LNJ276CK2AA

Round Type

 $\phi 3.2 \ mm$

Absolute Maximum Ratings $T_a = 25^{\circ}C$

| Parameter | Symbol | Rating | Unit | |
|-------------------------------|------------------|-------------|------|--|
| Power dissipation | P _D | 80 | mW | |
| Forward current | I _F | 30 | mA | |
| Pulse forward current * | I _{FP} | 100 | mA | |
| Reverse voltage | V _R | 4 | V | |
| Operating ambient temperature | T _{opr} | -25 to +85 | °C | |
| Storage temperature | T _{stg} | -30 to +100 | °C | |

Lighting Color

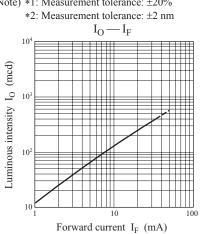
• Red

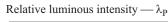
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

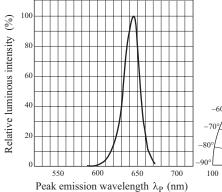
Electro-Optical Characteristics $T_a = 25^{\circ}C$

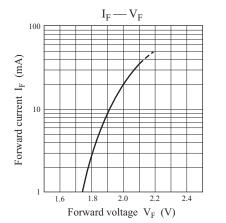
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|---------------------------------|------------------------|-----------------------|-----|-----|-----|------|
| Luminous intensity *1 | Io | $I_F = 20 \text{ mA}$ | 130 | 260 | | mcd |
| Reverse current | I _R | $V_R = 4 V$ | | | 100 | μΑ |
| Forward voltage | V _F | $I_F = 20 \text{ mA}$ | | 2.0 | 2.6 | V |
| Dominant emission wavelength *2 | λ_d | $I_F = 20 \text{ mA}$ | | 632 | | nm |
| Peak emission wavelength | λ_{P} | $I_F = 20 \text{ mA}$ | | 645 | | nm |
| Spectral half band width | Δλ | $I_F = 20 \text{ mA}$ | | 17 | | nm |

Note) *1: Measurement tolerance: ±20%

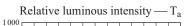


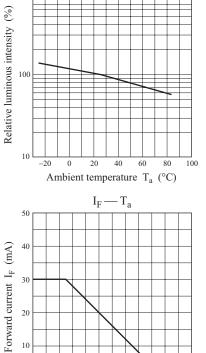






Directive characteristics





60 80

Ambient temperature T_a (°C)

20 0

20 40 60 80 100

80 60 40

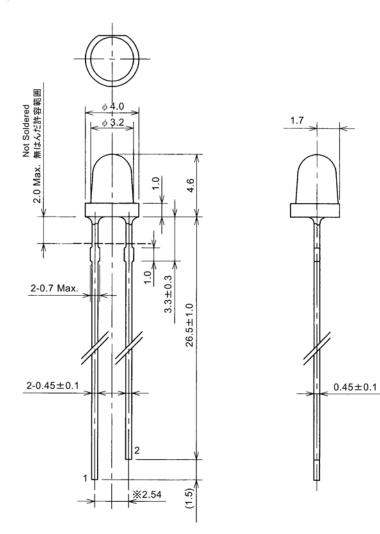
80°

0

20 40

100 120

Package (Unit: mm)



• Pin name

1: Anode

2: Cathode

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